Dual low-ohmic double-pole double-throw analog switch

3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1.Ordering information

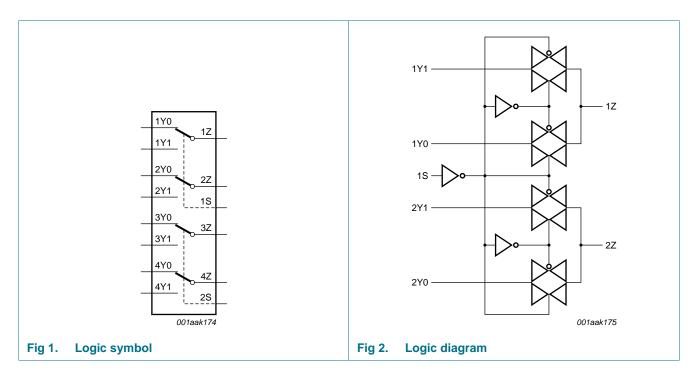
Type number	Package								
	Temperature range	Name	Description	Version					
NX3L2467PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					
NX3L2467HR	–40 °C to +125 °C	HXQFN16	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; body $3 \times 3 \times 0.5$ mm	SOT1039-2					
NX3L2467GU	–40 °C to +125 °C	XQFN16	plastic, extremely thin quad flat package; no leads; 16 terminals; body $1.80 \times 2.60 \times 0.50$ mm	SOT1161-1					

5. Marking

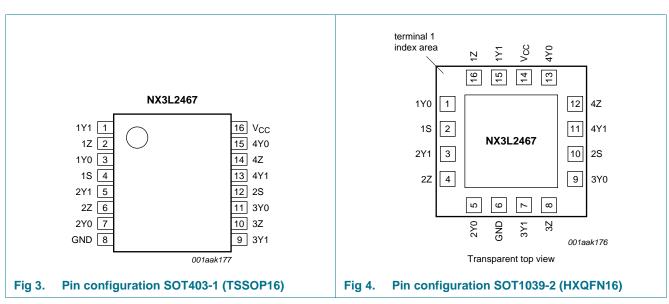
Table 2. Marking codes	
Type number	Marking code
NX3L2467PW	X3L2467
NX3L2467HR	D67
NX3L2467GU	D67

Dual low-ohmic double-pole double-throw analog switch

6. Functional diagram



7. Pinning information

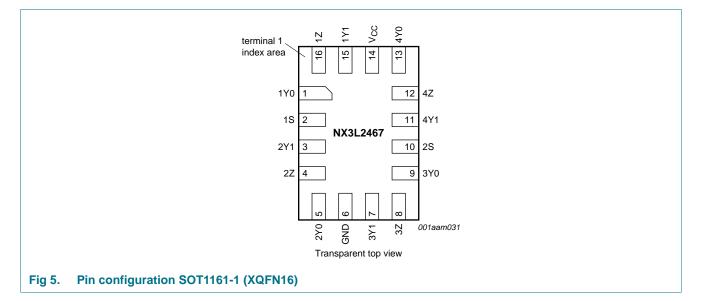


7.1 Pinning

NX3L2467

NX3L2467

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7.2 Pin description

Symbol	Pin		Description
	SOT1039-2 and SOT1161-1	SOT403-1	
1Y0, 2Y0, 3Y0, 4Y0	1, 5, 9, 13	3, 7, 11, 15	independent input or output
1S, 2S	2, 10	4, 12	select input
1Y1, 2Y1, 3Y1, 4Y1	15, 3, 7, 11	1, 5, 9, 13	independent input or output
1Z, 2Z, 3Z, 4Z	16, 4, 8, 12	2, 6, 10, 14	common output or input
GND	6	8	ground (0 V)
V _{CC}	14	16	supply voltage

8. Functional description

Table 4.Function table

Input nS	Channel on
L	nY0
Н	nY1

[1] H = HIGH voltage level; L = LOW voltage level.

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	select input nS	<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		<u>[2]</u> –0.5	V _{CC} + 0	.5 V

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Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Max	Unit
input clamping current	$V_{I} < -0.5 V$	-50	-	mA
switch clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	-	±50	mA
switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	-	±350	mA
	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
storage temperature		-65	+150	°C
total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
	TSSOP16	<u>[3]</u> _	500	mW
	HXQFN16	<u>[4]</u> _	250	mW
	XQFN16	<u>[5]</u> _	250	mW
	input clamping current switch clamping current switch current storage temperature	$\label{eq:switch clamping current} \begin{array}{l} V_{I} < -0.5 \ V \\ \mbox{switch clamping current} & V_{I} < -0.5 \ V \ or \ V_{I} > V_{CC} + 0.5 \ V \\ \mbox{switch current} & V_{SW} > -0.5 \ V \ or \ V_{SW} < V_{CC} + 0.5 \ V; \\ \mbox{source or sink current} & V_{SW} > -0.5 \ V \ or \ V_{SW} < V_{CC} + 0.5 \ V; \\ \mbox{pulsed at 1 ms duration, < 10 \% duty cycle; } \\ \mbox{peak current} & \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	$\begin{tabular}{ c c c c } \hline $V_1 < -0.5 V & -50 \\ \hline $witch clamping current$ & $V_1 < -0.5 V or $V_1 > V_{CC} + 0.5 V & $-$ \\ \hline $witch current$ & $V_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $source or sink current$ & $V_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline $v_{SW} > -0.5 V or $V_{SW} < V_{CC} + 0.5 V; & $-$ \\ \hline v	input clamping current $V_1 < -0.5$ V -50 -50 switch clamping current $V_1 < -0.5$ V or $V_1 > V_{CC} + 0.5$ V $ \pm 50$ switch current $V_{SW} > -0.5$ V or $V_{SW} < V_{CC} + 0.5$ V; source or sink current $ \pm 350$ $V_{SW} > -0.5$ V or $V_{SW} < V_{CC} + 0.5$ V; pulsed at 1 ms duration, < 10 % duty cycle; peak current $ \pm 500$ storage temperature -65 $+150$ total power dissipation $T_{amb} = -40$ °C to $+125$ °C -65 $+150$ HXQFN16 $[3]$ - 500 $4]$ - 250

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For TSSOP16 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K above.

[4] For HXQFN16 package: above 135 °C the value of Ptot derates linearly with 16.9 mW/K.

[5] For XQFN16 package: above 133 °C the value of Ptot derates linearly with 14.5 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.4	4.3	V
VI	input voltage	select input nS	0	4.3	V
V _{SW}	switch voltage		<u>[1]</u> 0	V _{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.4 V to 4.3 V	[2] _	200	ns/V

[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

Dual low-ohmic double-pole double-throw analog switch

11. Static characteristics

Table 7. Static characteristics

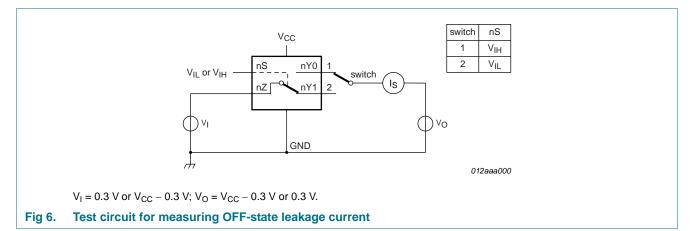
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

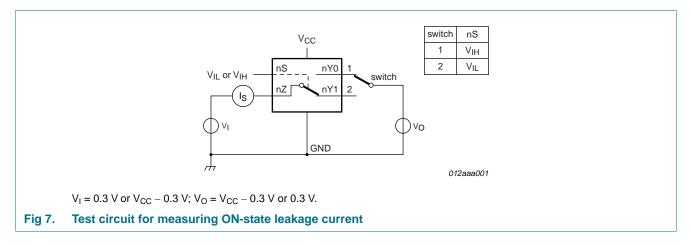
Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} = ·	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
VIH	HIGH-level	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	0.9	-	-	0.9	-	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	1.4	-	-	1.4	-	-	V
V _{IL}	LOW-level	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	-	0.3	-	0.3	0.3	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
I	input leakage current	select input nS; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)} OFF-state leakage current	nY0 and nY1 port; see <mark>Figure 6</mark>								
	current	V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±10	-	±50	±500	nA
I _{S(ON)}	ON-state leakage current	nZ port; V _{CC} = 1.4 V to 3.6 V; see Figure 7							
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC}							
		$V_{CC} = 3.6 V$	-	-	100	-	500	5000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	6000	nA
∆l _{CC}	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_1 = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μΑ
		$V_{I} = 2.6 V; V_{CC} = 3.6 V$	-	0.35	0.7	-	1	1	μΑ
		$V_{I} = 1.8 V; V_{CC} = 4.3 V$	-	7.0	10.0	-	15	15	μΑ
		$V_{I} = 1.8 V; V_{CC} = 3.6 V$	-	2.5	4.0	-	5	5	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
Cı	input capacitance		-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	130	-	-	-	-	pF

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11.1 Test circuits





11.2 ON resistance

Table 8. ON resistance^[1]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	o +85 ℃	T _{amb} = -40 °	Unit	
			Min	Typ[2]	Max	Min	Max	
R _{ON(peak)} ON resis (peak)		$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA; see Figure 8						
		V _{CC} = 1.4 V	-	1.7	3.7	-	4.1	Ω
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω
		V _{CC} = 2.3 V	-	0.6	0.8	-	0.9	Ω
		V _{CC} = 2.7 V	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω

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Symbol	Parameter	Conditions	Т	amb =	–40 °C to	o +85 °C	T _{amb} = -40 °	C to +125 °C	Unit
				Min	Typ ^[2]	Max	Min	Max	1
ΔR _{ON} ON resistance mismatch between channels	mismatch	$V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$	<u>[3]</u>				'		
	$V_{CC} = 1.4 \text{ V}; V_{SW} = 0.4 \text{ V}$		-	0.18	0.3	-	0.3	Ω	
	Charmeis	V_{CC} = 1.65 V; V_{SW} = 0.5 V		-	0.18	0.2	-	0.3	Ω
		$V_{CC} = 2.3 \text{ V}; V_{SW} = 0.7 \text{ V}$		-	0.07	0.1	-	0.13	Ω
		$V_{CC} = 2.7 \text{ V}; V_{SW} = 0.8 \text{ V}$		-	0.07	0.1	-	0.13	Ω
		$V_{CC} = 4.3 \text{ V}; V_{SW} = 0.8 \text{ V}$		-	0.07	0.1	-	0.13	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$	[4]						
		$V_{CC} = 1.4 V$		-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V		-	0.5	1.2	-	1.3	Ω
		$V_{CC} = 2.3 V$		-	0.15	0.3	-	0.35	Ω
		$V_{CC} = 2.7 V$		-	0.13	0.3	-	0.35	Ω
		$V_{CC} = 4.3 V$		-	0.2	0.4	-	0.45	Ω

Table 8. ON resistance^[1]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

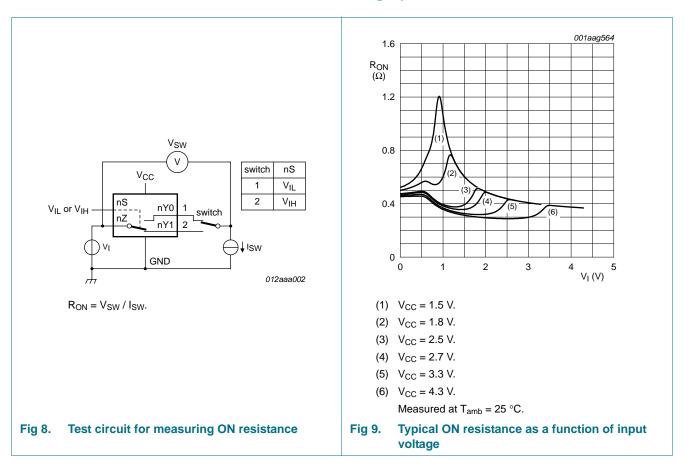
[1] For NX3L2467PW (TSSOP16 package), all ON resistance values are up to 0.05 Ω higher.

[2] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[3] Measured at identical V_{CC}, temperature and input voltage.

[4] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

Dual low-ohmic double-pole double-throw analog switch

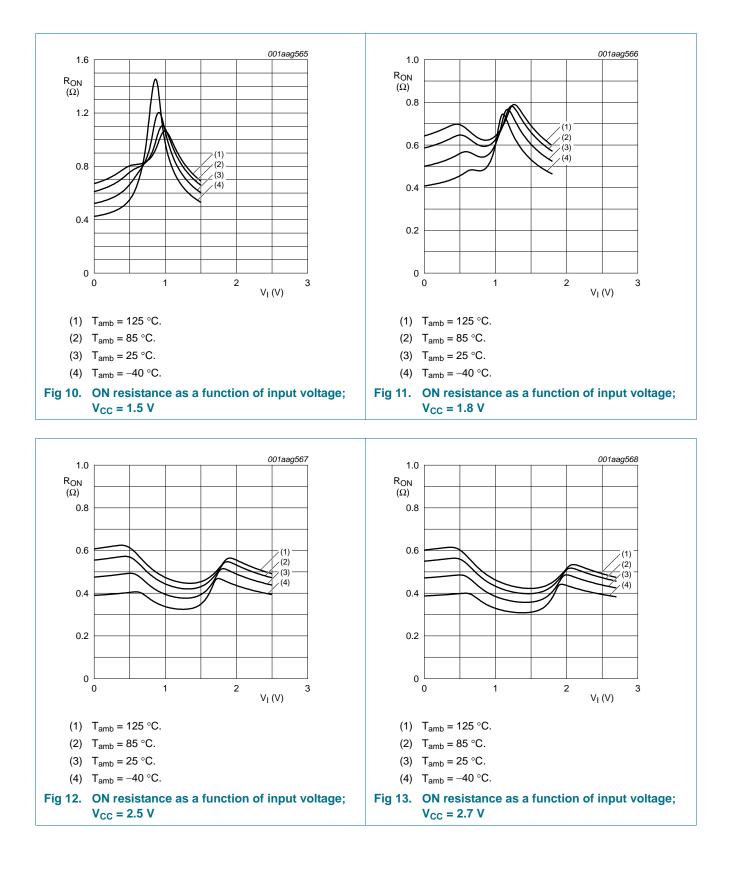


11.3 ON resistance test circuit and graphs

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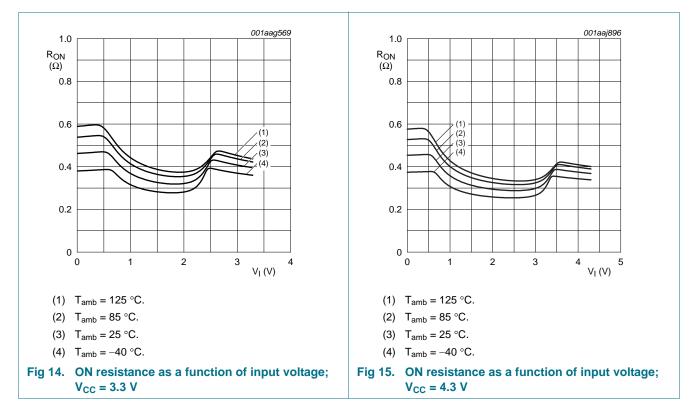
Dual low-ohmic double-pole double-throw analog switch



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Dual low-ohmic double-pole double-throw analog switch



12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 18.

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} = -40 °C to +125 °C			Unit
			Min	Тур <u>^[1]</u>	Max	Min	Max (85 °C)	Max (125 °C)	
t _{en} enable time	nS to nZ or nYn; see <u>Figure 16</u>								
	V_{CC} = 1.4 V to 1.6 V	-	41	90	-	120	120	ns	
	V _{CC} = 1.65 V to 1.95 V	-	30	70	-	80	90	ns	
		V_{CC} = 2.3 V to 2.7 V	-	20	45	-	50	55	ns
		V_{CC} = 2.7 V to 3.6 V	-	19	40	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	19	40	-	45	50	ns
t _{dis}	disable time	nS to nZ or nYn; see <u>Figure 16</u>							
		V_{CC} = 1.4 V to 1.6 V	-	24	70	-	80	90	ns
		V_{CC} = 1.65 V to 1.95 V	-	15	55	-	60	65	ns
		V_{CC} = 2.3 V to 2.7 V	-	9	25	-	30	35	ns
		V_{CC} = 2.7 V to 3.6 V	-	8	20	-	25	30	ns
		V_{CC} = 3.6 V to 4.3 V	-	8	20	-	25	30	ns

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Symbol	Parameter	Conditions		T _{amb} = 25 °C			T _{amb} =40 °C to +125 °C			Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
t _{b-m} break-before-make	see Figure 17	[2]								
	time	V_{CC} = 1.4 V to 1.6 V		-	20	-	9	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V		-	13	-	4	-	-	ns
		V_{CC} = 2.7 V to 3.6 V		-	11	-	3	-	-	ns
		V_{CC} = 3.6 V to 4.3 V		-	11	-	2	-	-	ns

Table 9. Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 18.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

12.1 Waveform and test circuits

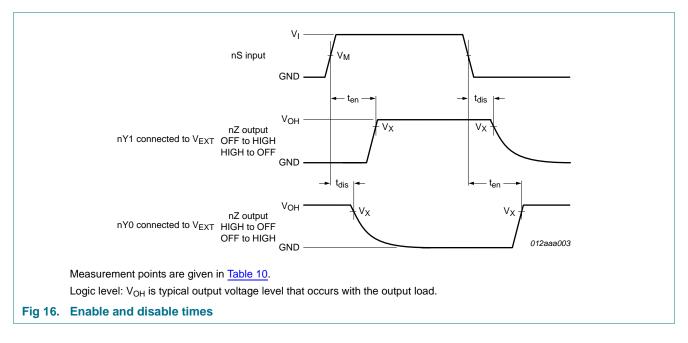
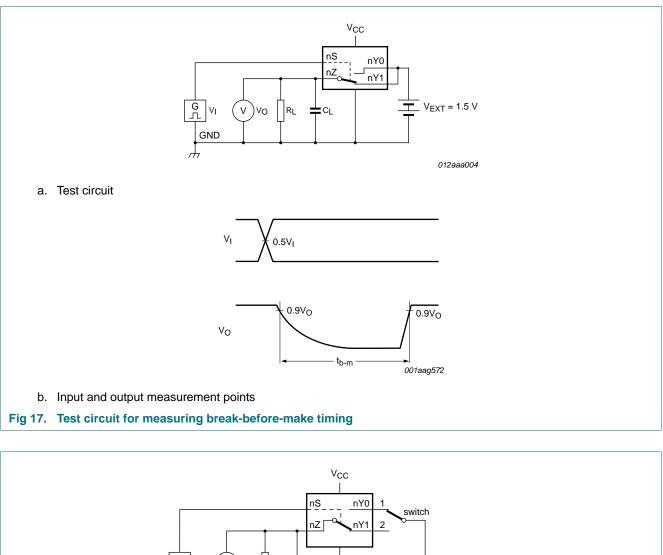


Table 10. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

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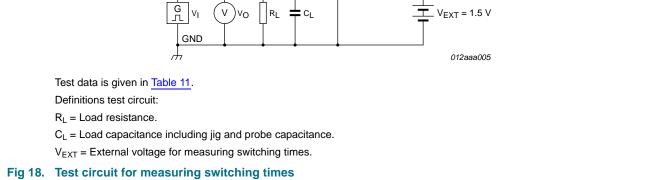


Table 11. Test data

Supply voltage	Input		Load	
V _{cc}	VI	t _r , t _f	CL	RL
1.4 V to 4.3 V	V _{CC}	\leq 2.5 ns	35 pF	50 Ω

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12.2 Additional dynamic characteristics

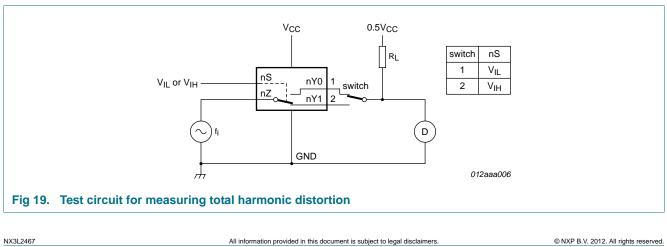
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 19}{1000 \text{ sec } 19}$	<u>[1]</u>			
		$V_{CC} = 1.4 \text{ V}; \text{ V}_{I} = 1 \text{ V} (p-p)$	-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)	-	0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)	-	0.02	-	%
		V _{CC} = 2.7 V; V ₁ = 2 V (p-p)	-	0.02	-	%
		V _{CC} = 4.3 V; V _I = 2 V (p-p)	-	0.02	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 20	[1]			
	response	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	60	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 21}}{100 \text{ kHz}}$	[1]			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 22				
		V _{CC} = 1.4 V to 3.6 V	-	0.2	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	0.3	-	V
Xtalk cr	crosstalk	between switches; $f_i = 100 \text{ kHz}$; $R_L = 50 \Omega$; see <u>Figure 23</u>	[1]			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-90	-	dB
Q _{inj}	charge injection	$f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure } 24}{2}$				
		$V_{CC} = 1.5 V$	-	3	-	рС
		V _{CC} = 1.8 V	-	4	-	рС
		$V_{CC} = 2.5 V$	-	6	-	рС
		$V_{CC} = 3.3 V$	-	9	-	рС
		$V_{CC} = 4.3 V$	-	15	-	рС

[1] f_i is biased at 0.5V_{CC}.

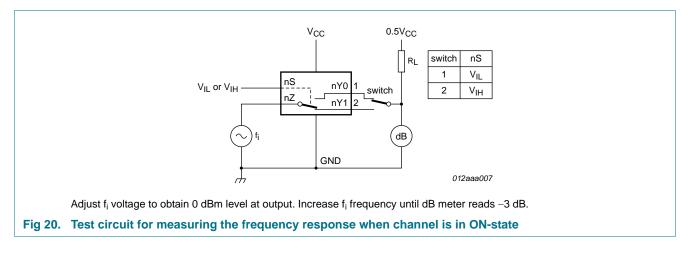
12.3 Test circuits

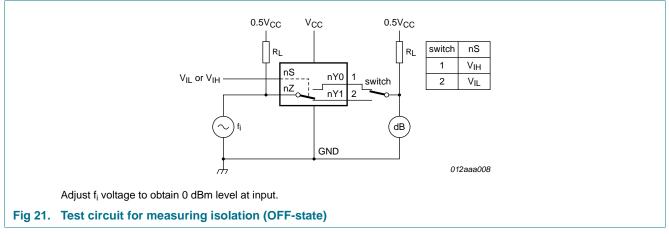


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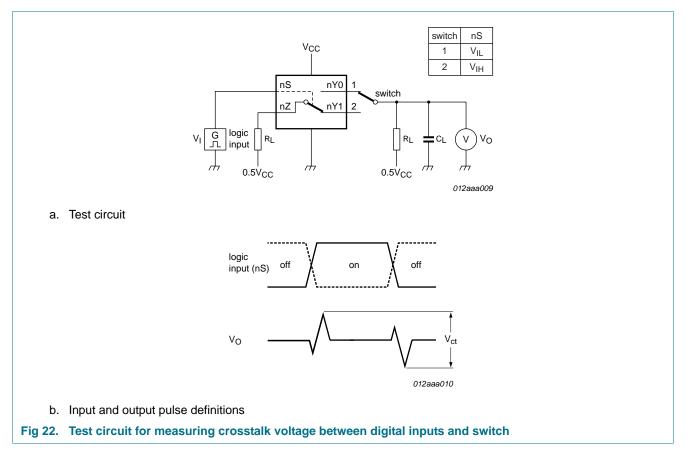
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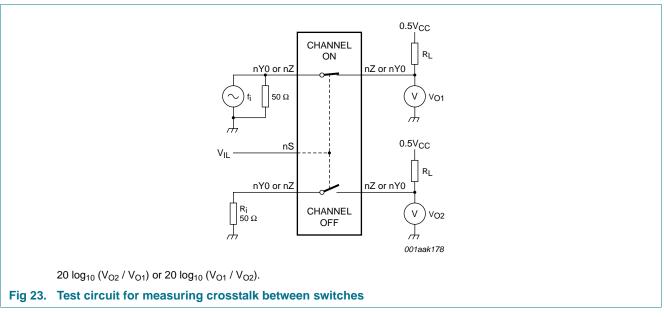
Dual low-ohmic double-pole double-throw analog switch





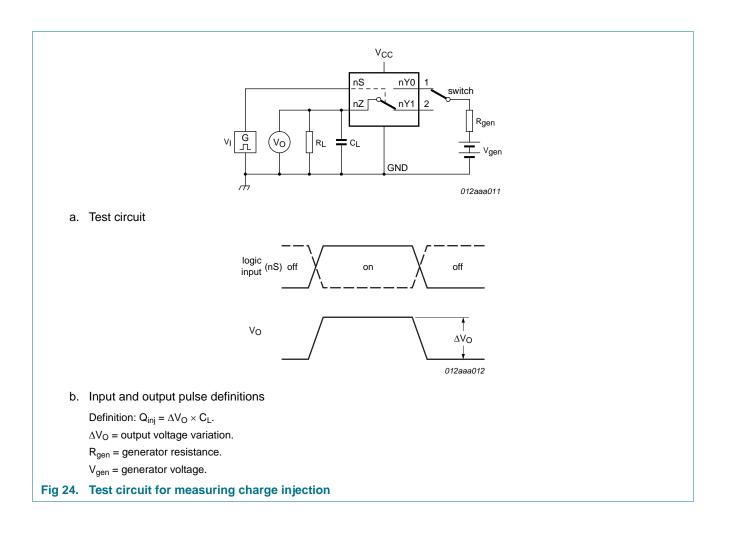
Dual low-ohmic double-pole double-throw analog switch





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13. Package outline

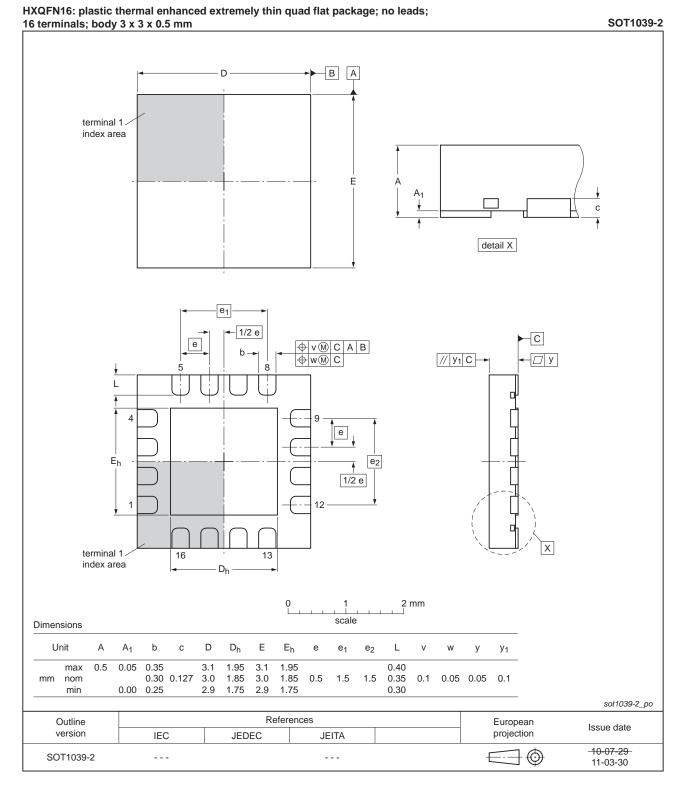


Fig 25. Package outline SOT1039-2 (HXQFN16)

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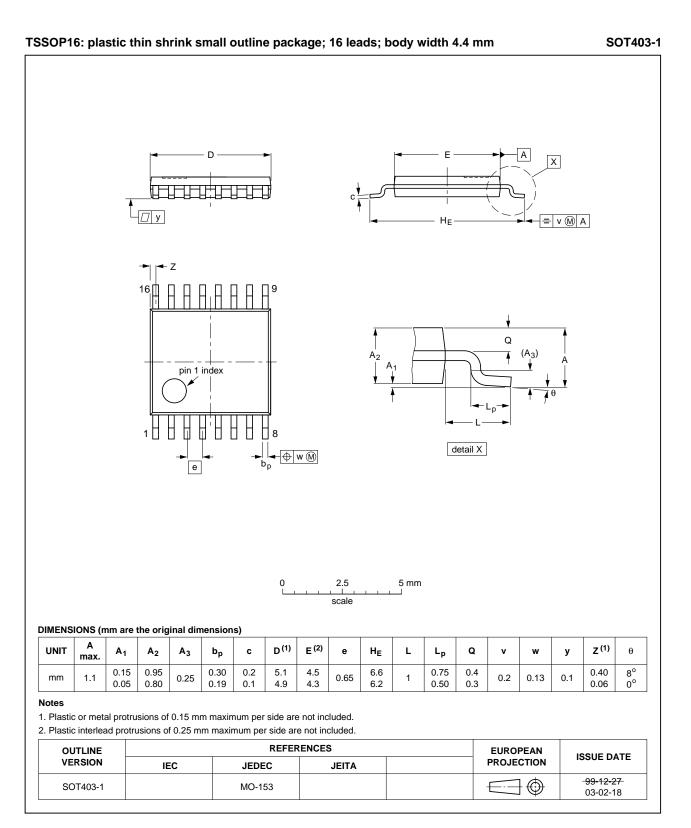


Fig 26. Package outline SOT403-1 (TSSOP16)

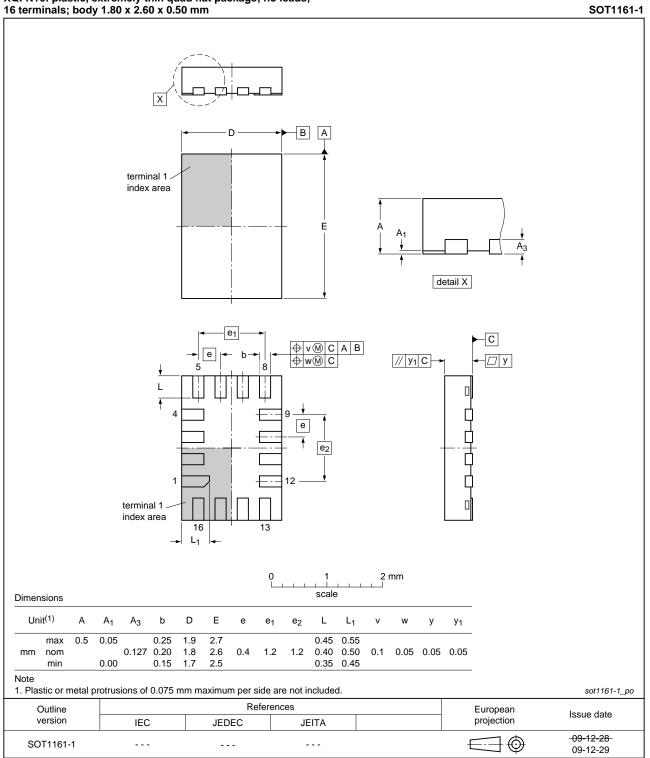
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XQFN16: plastic, extremely thin quad flat package; no leads; 16 terminals; body 1.80 x 2.60 x 0.50 mm

Fig 27. Package outline SOT1161-1 (XQFN16)

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14. Abbreviations

Table 13. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
PDA	Personal Digital Assistant			

15. Revision history

Table 14. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
NX3L2467 v.5	20120702	Product data sheet	-	NX3L2467 v.4	
Modifications:	 For type nur 	mber NX3L2467HR the sot	code has changed to SO	OT1039-2.	
NX3L2467 v.4	20111108	Product data sheet	-	NX3L2467 v.3	
Modifications:	 Legal pages 	s updated.			
NX3L2467 v.3	20101229	Product data sheet	-	NX3L2467 v.2	
NX3L2467 v.2	20100519	Product data sheet	-	NX3L2467 v.1	
NX3L2467 v.1	20090623	Product data sheet	-	-	

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16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Product data sheet

Dual low-ohmic double-pole double-throw analog switch

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